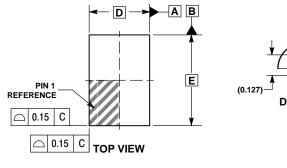


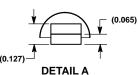


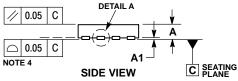
### UDFN8 3.0x2.0, 0.5P CASE 517BU ISSUE O

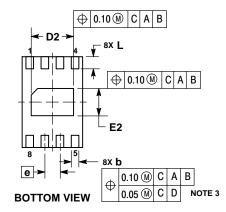
**DATE 06 APR 2011** 

# SCALE 4:1

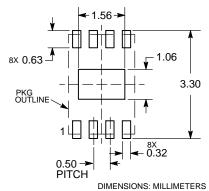








#### **RECOMMENDED MOUNTING FOOTPRINT**



#### NOTES:

- JTES:

  DIMENSIONING AND TOLERANCING PER
  ASME Y14.5M, 1994.

  CONTROLLING DIMENSION: MILLIMETERS.
  DIMENSIONS b APPLIES TO PLATED
  TERMINAL AND IS MEASURED BETWEEN
  0.15 AND 0.25 MM FROM TERMINAL TIP.
  COPLANARITY APPLIES TO THE EXPOSED
  PAD AS WELL AS THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
Α	0.45	0.55
A1	0.00	0.05
b	0.20	0.30
D	2.00 BSC	
D2	1.35	1.45
E	3.00 BSC	
E2	0.85	0.95
е	0.50 BSC	
L	0.35	0.45

## **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Assembly Location Code

= Assembly Lot LL

Υ = Year

= Month

= Pb Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb Free indicator, "G" or microdot " ■", may or may not be present.

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